

STS7PF30L

P-CHANNEL 30V - 0.16Ω - 7A - SO-8 STripFET™ II Power MOSFET

General features

| v.DataSheet4L | Type .com | V _{DSS} | R _{DS(on)} | Ι _D |
|---------------|--------------|------------------|---------------------|----------------|
| | STS7PF30L | 30V | <0.021Ω | 7A |

- STANDARD OUTLINE FOR EASY AUTOMATED SURFACE MOUNT ASSEMBLY
- LOW THRESHOLD DRIVE

Description

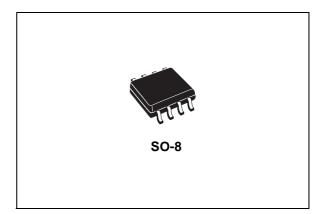
This Power MOSFET is the latest development of STMicroelectronics' unique "Single Feature Size™" strip-based process. The resulting transistor shows extremely high packing densisty for low on-resistance, rugged avalanche characteristics and less critical alignment steps, therefore a remarkable manufacturing reproducibility.

Applications

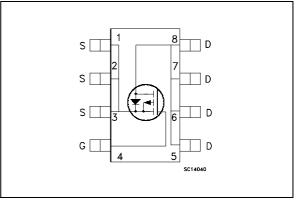
- BATTERY MANAGEMENT IN NOMADIC EQUIPMENT.
- BATTERY MANAGEMENT IN NOMADIC EQUIPMENT

Order Codes

| Sales Type | Marking | Package | Packaging |
|------------|---------|---------|-------------|
| STS7PF30L | S7PF30L | SO-8 | TAPE & REEL |



Internal schematic diagram



1 Electrical ratings

| Symbol | Parameter | Value | Unit | | | | |
|------------------------|--|-------|------|--|--|--|--|
| V _{DS} | Drain-Source Voltage (V _{GS} = 0) | 30 | V | | | | |
| V _{DGR} | Drain-gate Voltage ($R_{GS} = 20k\Omega$) | 30 | V | | | | |
| V _{GS} | Gate-Source Voltage | ± 20 | V | | | | |
| com I _D | Drain Current (continuous) at T _C = 25°C | 7 | А | | | | |
| ۱ _D | Drain Current (continuous) at T _C = 100°C | 4.4 | А | | | | |
| I _{DM} Note 1 | Drain Current (pulsed) | 28 | А | | | | |
| P _{TOT} | Total Dissipation at $T_{C} = 25^{\circ}C$ | 2.5 | W | | | | |

Table 1. Absolute maximum ratings

Table 2. Thermal data

| Rthj-amb <i>Note</i> 2 | Thermal Resistance Junction-ambient | 50 | °C/W |
|---------------------------|-------------------------------------|------------|------|
| T _j | Operating Junction Temperature | 150 | ာ |
| T _{stg} | Storage Temperature Range | -55 to 150 | သိ |



Electrical characteristics 2

(T_J = 25 °C unless otherwise specified)

| Symbol | Parameter Test Conditions | | Min. | Тур. | Max. | Unit |
|--|--|---|----------------|----------------|----------------|----------|
| V _{(BR)DSS} Drain-Source Breakdown Voltage | | I _D = 250μA, V _{GS} = 0 | 30 | | | V |
| l.com I _{DSS} | Zero Gate Voltage Drain Current (V _{GS} = 0) | V _{DS} = Max Rating, V _{DS} = Max Rating, T _c =125°C | | | 1 10 | μΑ μΑ |
| I _{GSS} | Gate Body Leakage Current (V _{DS} = 0) | $V_{DS} = \pm 16V$ | | | ±100 | nA |
| V _{GS(th)} | Gate Threshold Voltage | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | 1 | 1.6 | 2.5 | V |
| R _{DS(on)} | Static Drain-Source On Resistance | V _{GS} = 10 V, I _D = 3.5A V _{GS} = 4.5 V, I _D = 3.5A | 0.011 0.016 | 0.016 0.022 | 0.021 0.028 | Ω Ω |

Table 3. **On/off states**

Table 4. Dynamic

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|--|---|---|------|---------------------|------|----------------|
| g _{fs} Note 3 | Forward Transconductance | V _{DS} = 20V _, I _D = 3.5A | | 16 | | S |
| C _{iss} C _{oss} C _{rss} | Input Capacitance Output Capacitance Reverse Transfer Capacitance | V _{DS} = 25V, f = 1MHz, V _{GS} =0 | | 2600 523 174 | | pF pF pF |
| Q _g Q _{gs} Q _{gd} | Total Gate Charge Gate-Source Charge Gate-Drain Charge | V _{DD} = 15V, I _D = 7A, V _{GS} = 4.5V | | 28 8.75 12.35 | 7 | nC nC nC |

Table 5. Switching times

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|---------------------------------------|----------------------------------|--|------|----------|------|----------|
| t _{d(on)} t _r | Turn-on Delay Time Rise Time | $V_{DD} = 15V, I_D = 3.5A$ $R_G = 4.7\Omega, V_{GS} = 4.5V,$ (see Figure 13) | | 68 54 | | ns ns |
| t _{d(off)} t _f | Turn-off Delay Time Fall Time | $V_{DD} = 15V, I_D = 3.5A$ $R_G = 4.7\Omega, V_{GS} = 4.5V,$ (see Figure 13) | | 65 23 | | ns ns |

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|--|--|---|------|-----------------|---------|---------------|
| I _{SD} I _{SDM} Note 1 | Source-Drain Current Source-Drain Current (pulsed) | | | | 7 28 | A A |
| V _{SD} | Forward On Voltage | I _{SD} = 7A, V _{GS} = 0 | | | 1.2 | V |
| t _{rr} Q _{rr} I _{RRM} | Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current | I _{SD} = 7A, di/dt = 100A/μs V _{DD} = 15V, Τ _j = 150°C (see Figure 15) | | 40 46 2.3 | | ns nC A |

Table 6. Source-Drain Diode

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(1) Pulse with limited by safe operating area

(2) When mounted on 1inch² FR-4 board (t \leq 10µs)

(3) Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

Note: For the P-CHANNEL MOSFET the polarity of voltages and current have to be reversed



094480

 $Z_{th} = k R_{thJ-c}$

 $10^{-1} t_{P}(s)$

 $\delta = t_{\rm p}/\tau$

10⁻²

Electrical characteristics (curves) 2.1

Figure 1. Safe Operating Area



28010

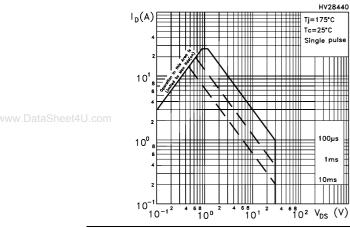
d=0.5

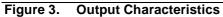
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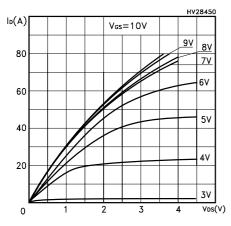
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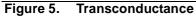
 10^{-2}

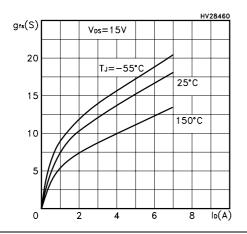
10⁻⁵



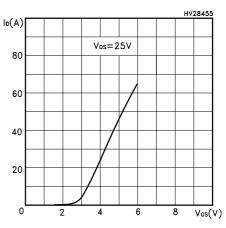








10⁻⁴ **Transfer Characteristics** Figure 4.



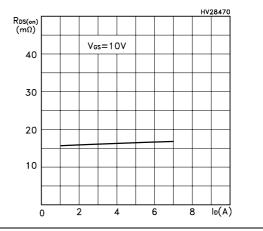
0.05 0.02

10. 01

 10^{-3}

SINGLE PULSE

Figure 6. Static Drain-Source on Resistance



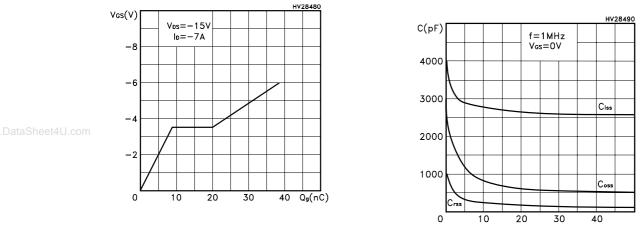
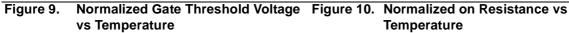


Figure 7. Gate Charge vs Gate-Source Voltage Figure 8. Capacitance Variations



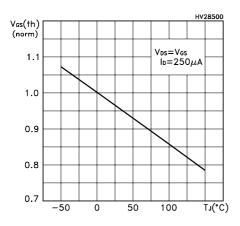
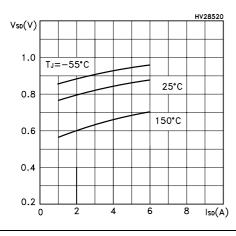


Figure 11. Source-Drain Diode Forward Characteristics



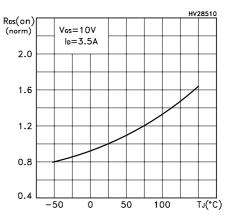
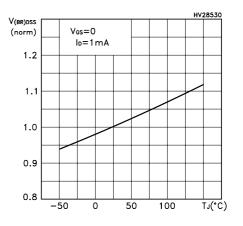


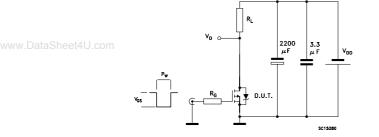
Figure 12. Normalized Breakdown Voltage vs Temperature



3 Test Circuits

Figure 13. Switching Times Test Circuit For Resistive Load

Figure 14. Gate Charge Test Circuit



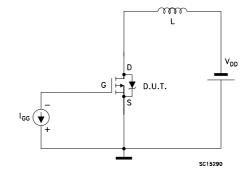
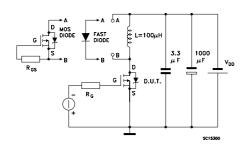


Figure 15. Test Circuit For Inductive Load Switching and Diode Recovery Times



4 Package Mechanical Data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

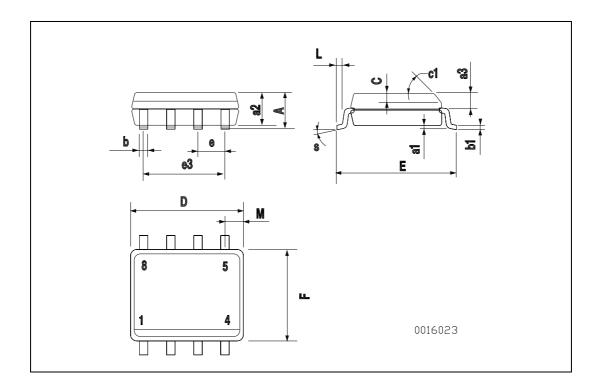
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| SO-8 MECHANICAL DATA | | | | | | |
|----------------------|------|------|------|--------|-------|-------|
| DIM. | | mm. | | | | |
| DIM. | MIN. | TYP | MAX. | MIN. | TYP. | MAX. |
| А | | | 1.75 | | | 0.068 |
| a1 | 0.1 | | 0.25 | 0.003 | | 0.009 |
| a2 | | | 1.65 | | | 0.064 |
| a3 | 0.65 | | 0.85 | 0.025 | | 0.033 |
| b | 0.35 | | 0.48 | 0.013 | | 0.018 |
| b1 | 0.19 | | 0.25 | 0.007 | | 0.010 |
| С | 0.25 | | 0.5 | 0.010 | | 0.019 |
| c1 | | | 45 (| (typ.) | | |
| D | 4.8 | | 5.0 | 0.188 | | 0.196 |
| Е | 5.8 | | 6.2 | 0.228 | | 0.244 |
| е | | 1.27 | | | 0.050 | |
| e3 | | 3.81 | | | 0.150 | |
| F | 3.8 | | 4.0 | 0.14 | | 0.157 |
| L | 0.4 | | 1.27 | 0.015 | | 0.050 |
| М | | | 0.6 | | | 0.023 |
| S | | 1 | 8 (n | nax.) | • | |



5 Revision History

| Date | Revision | Changes |
|-------------|----------|---------------------------|
| 13-Dec-2003 | 1 | First Issue |
| 25-Jun-2004 | 2 | Preliminary Data |
| 18-Jan-2005 | 3 | Modified value on table 5 |
| 29-Sep-2005 | 4 | Complete version |
| 09-Nov-2005 | 5 | New template |

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11/11